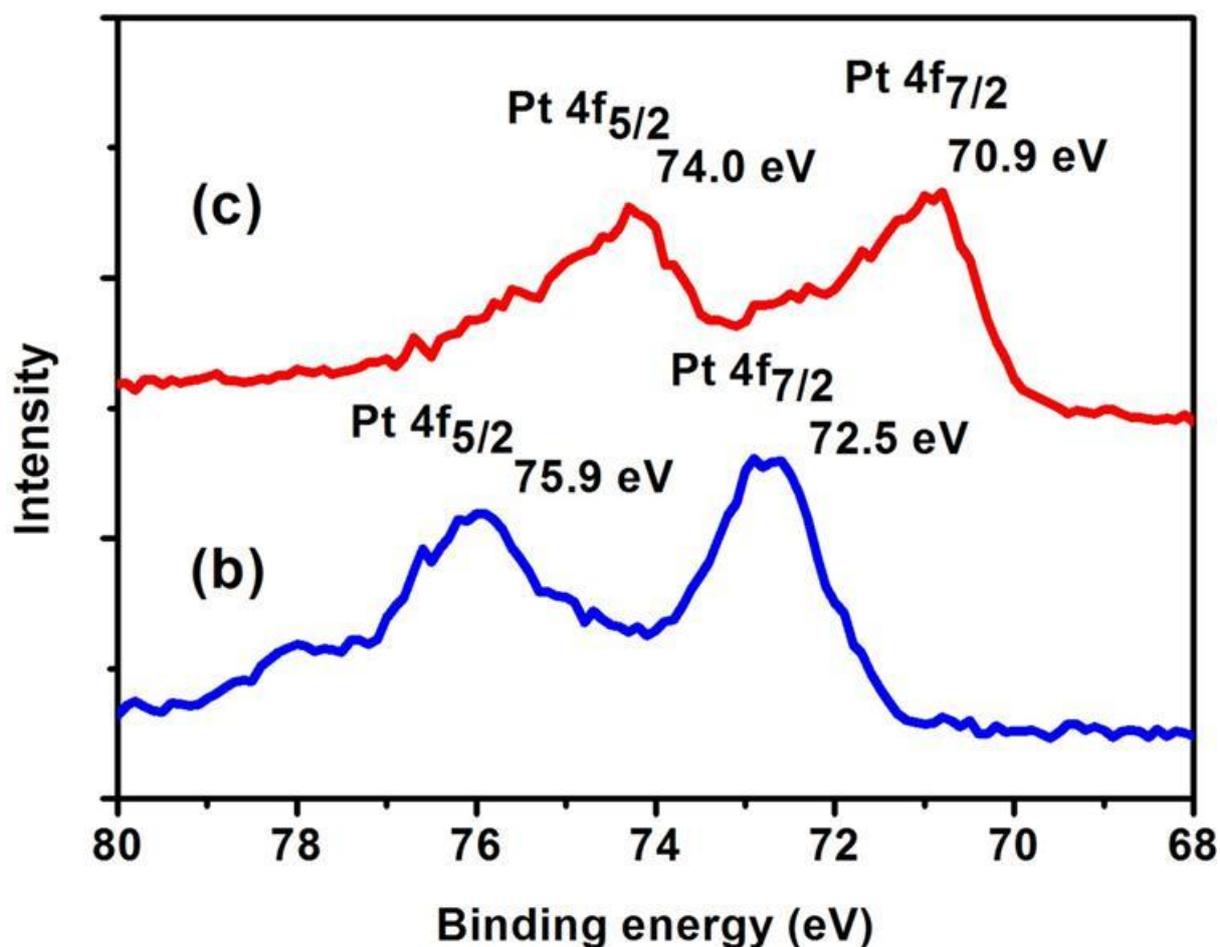


**Dry Plasma Reduction to Supported Platinum Nanoparticles for Flexible Dye-sensitized  
Solar Cells**

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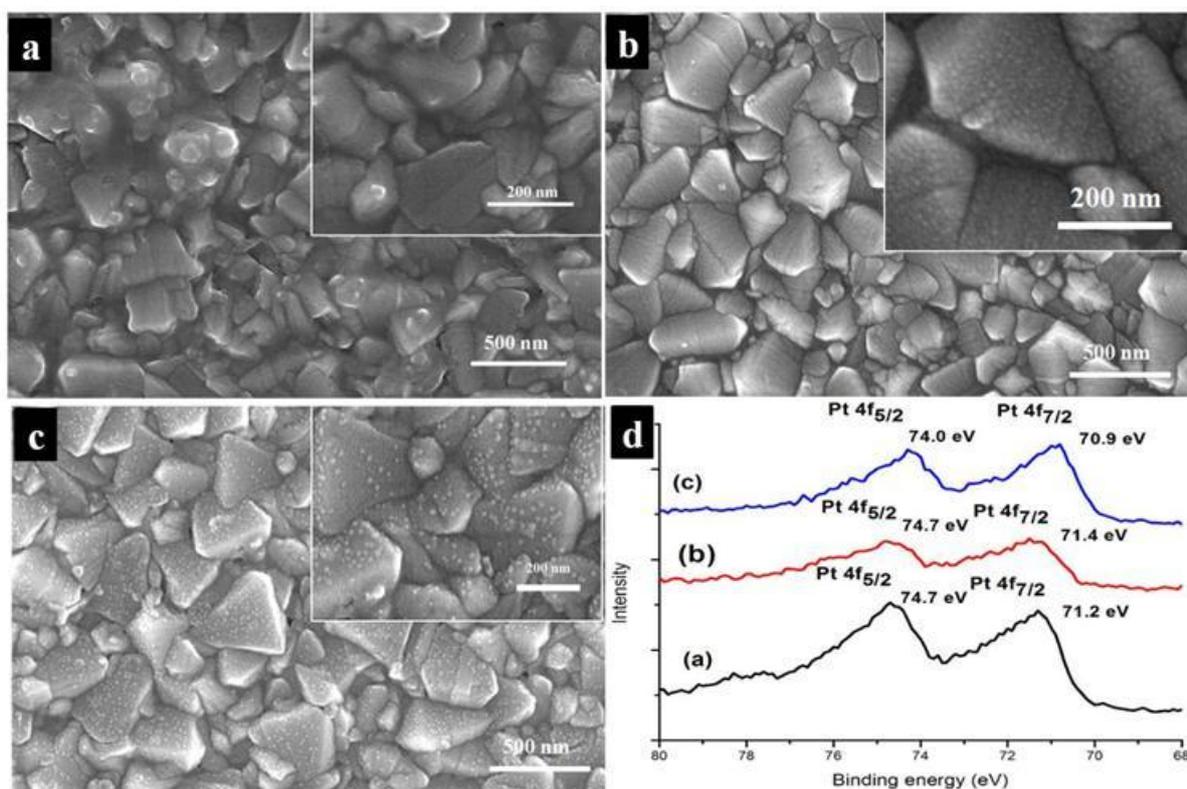
**Figure S1.** XPS spectra of sample (b), and sample (c), respectively, in Fig. 1.

**Table S1.** Percentage of elemental composition on the surface of FTO glass.

Sample	Elemental Composition (%)			
	Sn	O	Pt	Cl
(b)	14.55	25.6	15.73	44.12
(c)	31.65	54.88	13.47	0

(b) Before plasma reduction; (c) after plasma reduction

Fig. S1 shows the XPS spectra of FTO glass (b) after drying solvent, and (c) after DPR under pre-optimized conditions. Table S1 represents the elemental composition on the surface of the two samples of (b) and (c).



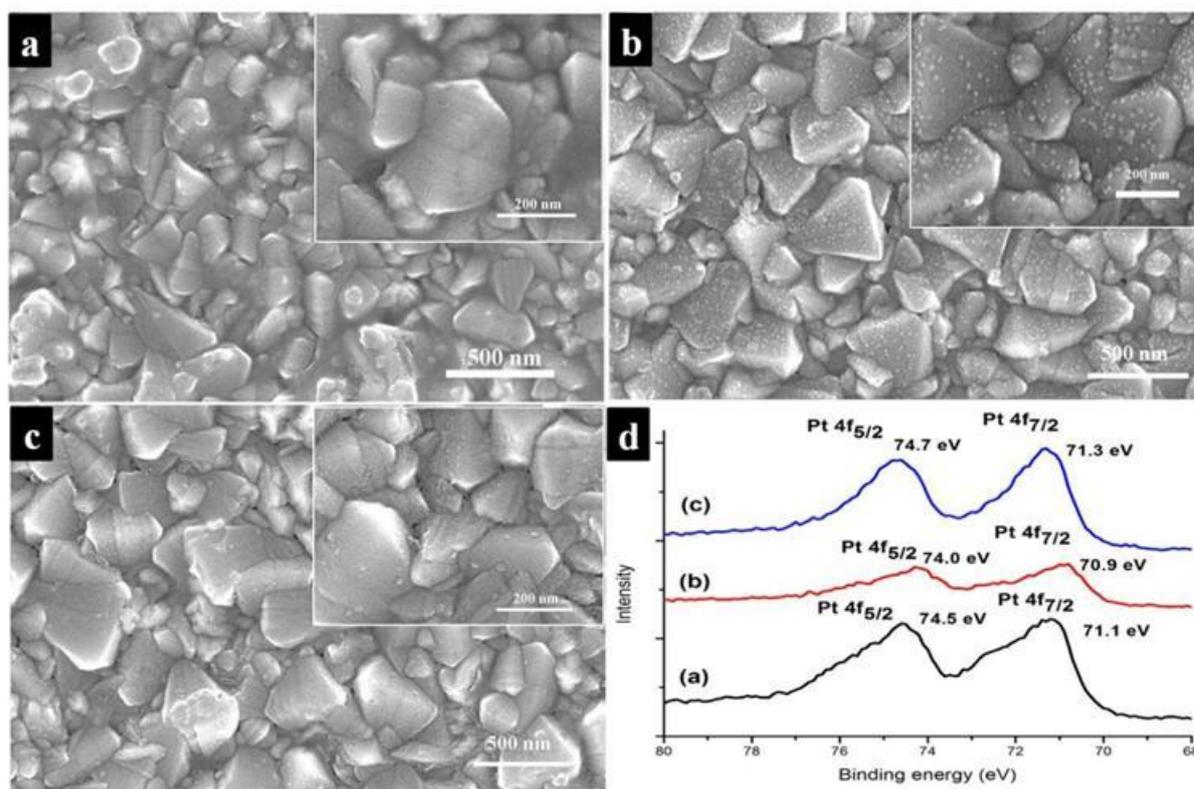
**Figure S2.** HRSEM images of Pt-NPs on FTO glass substrates treated for (a) 1 min, (b) 5 min, and (c) 15 min. The precursor solution has the  $\text{H}_2\text{PtCl}_6 \cdot x\text{H}_2\text{O}$  concentration of 10 mM. Other plasma treatment conditions include the power of 150 W, the Ar flow rate of 5 lpm, and the substrate moving speed of 5 mm/s. (d) XPS spectra of samples of (a), (b), and (c).

**Table S2.** Percentage of elemental composition on the surface of FTO glass.

Sample	Elemental Composition (%)			
	Sn	O	Pt	Cl
(a)	12.80	68.43	9.77	9.00
(b)	13.02	76.07	5.44	5.46
(c)	31.65	54.88	13.47	0

**Table S3.** Change of atomic ratio during plasma reduction.

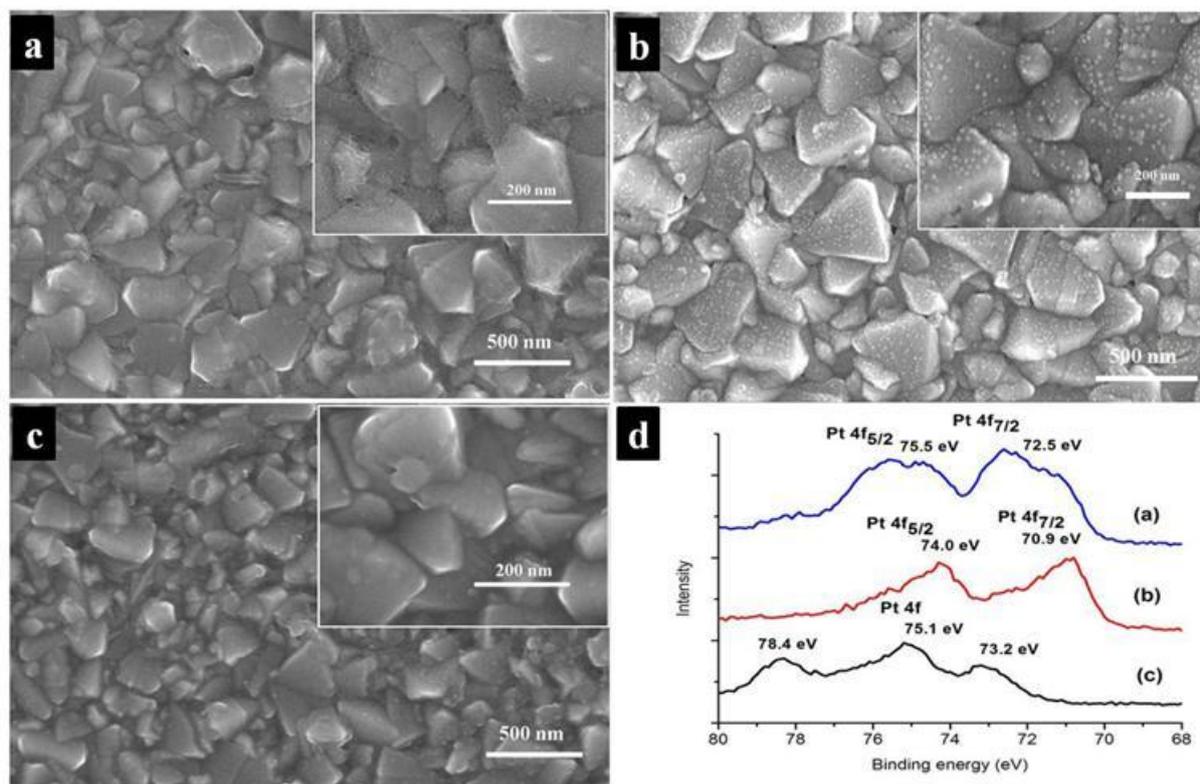
Time Reduction	Cl/Sn	Pt/Sn	Cl/Pt	O/Sn
0	3.03	1.08	2.8	1.7
1	0.70	0.76	0.9	5.3
5	0.42	0.42	1.0	5.8
15	0	0.42	0	1.7



**Figure S3.** HRSEM images of Pt-NPs on FTO glass substrates treated at the powers of (a) 100 W, (b) 150 W, and (c) 200 W. The precursor solution has the  $\text{H}_2\text{PtCl}_6 \cdot x\text{H}_2\text{O}$  concentration of 10 mM. Other plasma treatment conditions include the treatment time of 15 min, the Ar flow rate of 5 lpm, and the substrate moving speed of 5 mm/s. (d) XPS spectra of samples (a), (b), and (c).

**Table S4.** Percentage of elemental composition on the surface of FTO glass.

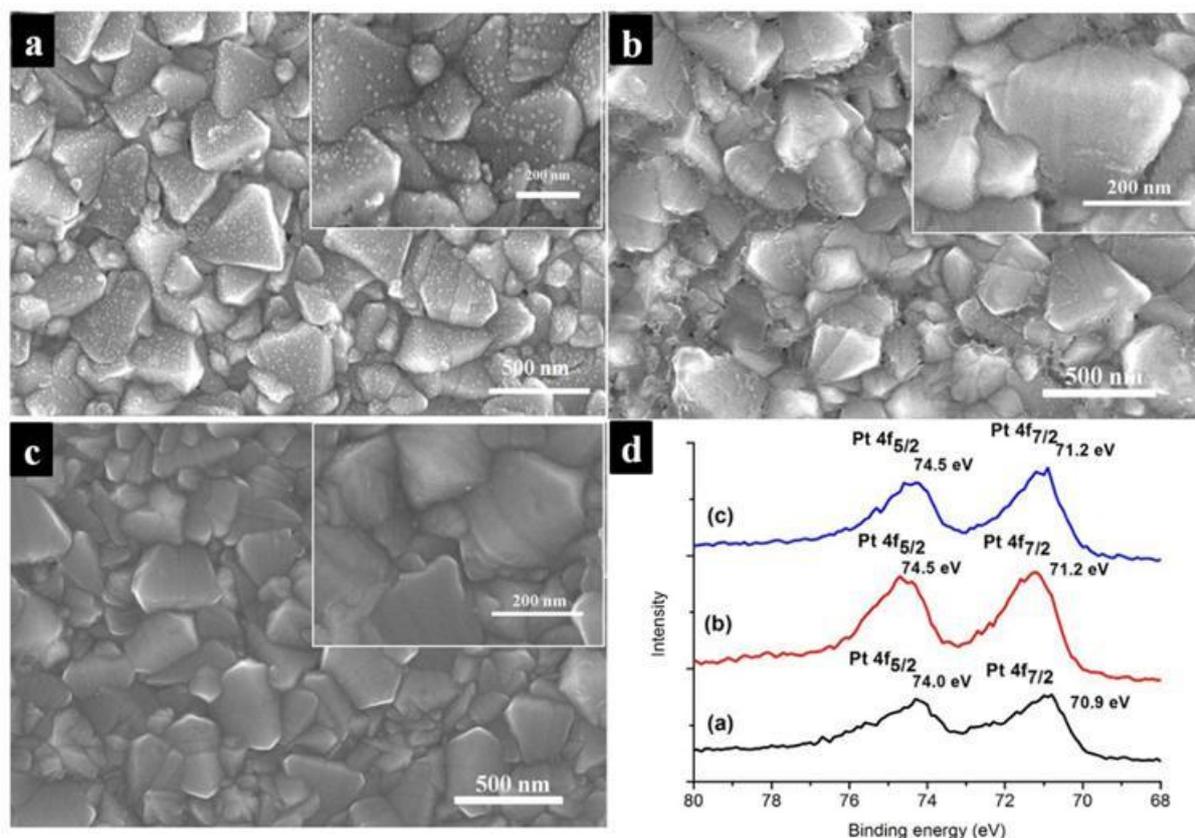
Sample	Elemental Composition (%)			
	Sn	O	Pt	Cl
(a)	12.12	51.93	19.48	16.47
(b)	31.65	54.88	13.47	0
(c)	16.71	58.15	14.93	10.2



**Figure S4.** HRSEM images of Pt-NPs on FTO glass substrates treated at the Ar flow rates of (a) 2 lpm, (b) 5 lpm, and (c) 7 lpm. The precursor solution has the  $\text{H}_2\text{PtCl}_6 \cdot x\text{H}_2\text{O}$  concentration of 10 mM. Other plasma treatment conditions include the treatment time of 15 min, the power of 150 W, and the substrate moving speed of 5 mm/s. (d) XPS spectra of samples (a), (b), and (c).

**Table S5.** Percentage of elemental composition on the surface of FTO glass.

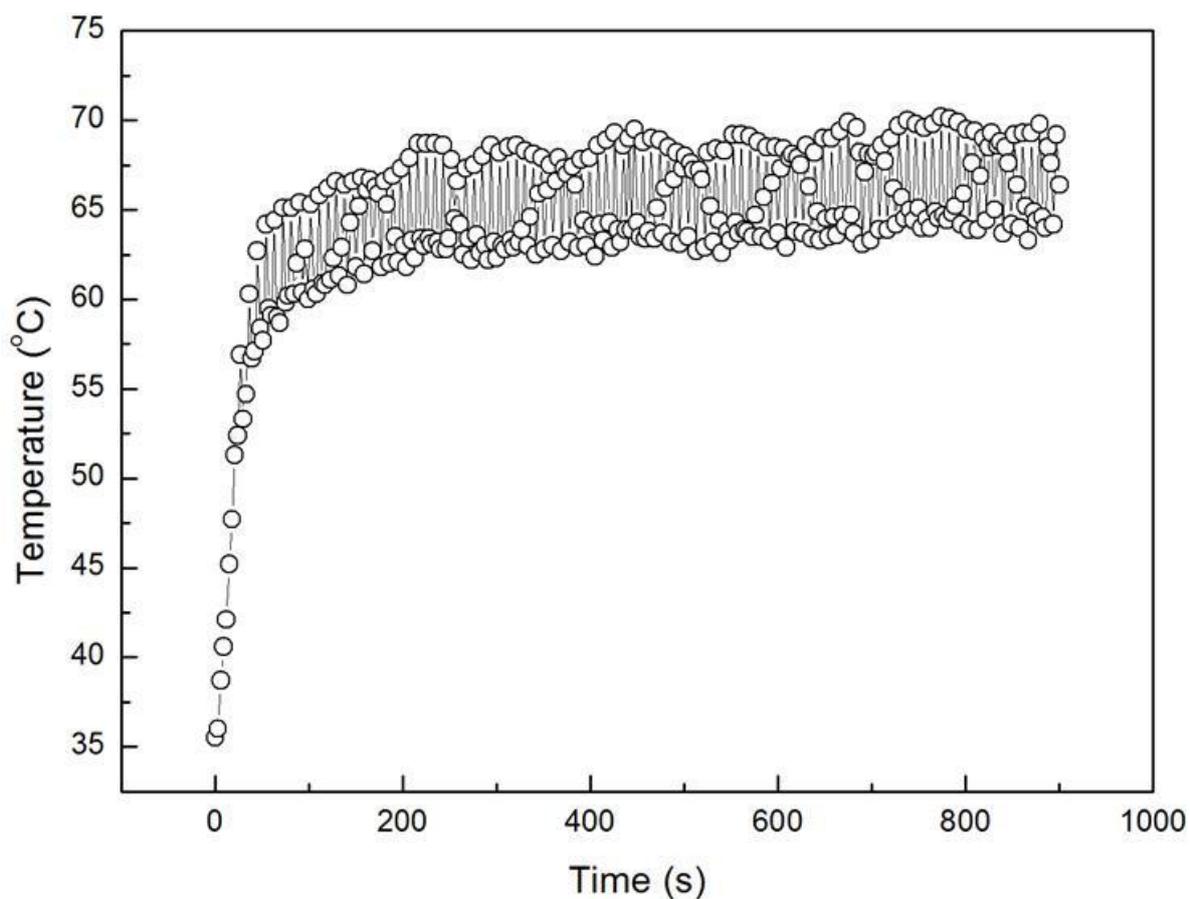
Sample	Elemental Composition (%)			
	Sn	O	Pt	Cl
(a)	9.85	69.63	8.65	11.86
(b)	31.65	54.88	13.47	0
(c)	45.21	18.2	12.4	24.16



**Figure S5.** HRSEM images of Pt-NPs on FTO-glass substrate treated at the moving speeds of (a) 5 mm/s, (b) 10 mm/s, and (c) 15 mm/s. The precursor solution has the  $\text{H}_2\text{PtCl}_6 \cdot x\text{H}_2\text{O}$  concentration of 10 mM. Other plasma treatment conditions include the treatment time of 15 min, the power of 150 W, and the Ar flow rate of 5 lpm. (d) XPS spectra of samples (a), (b), and (c).

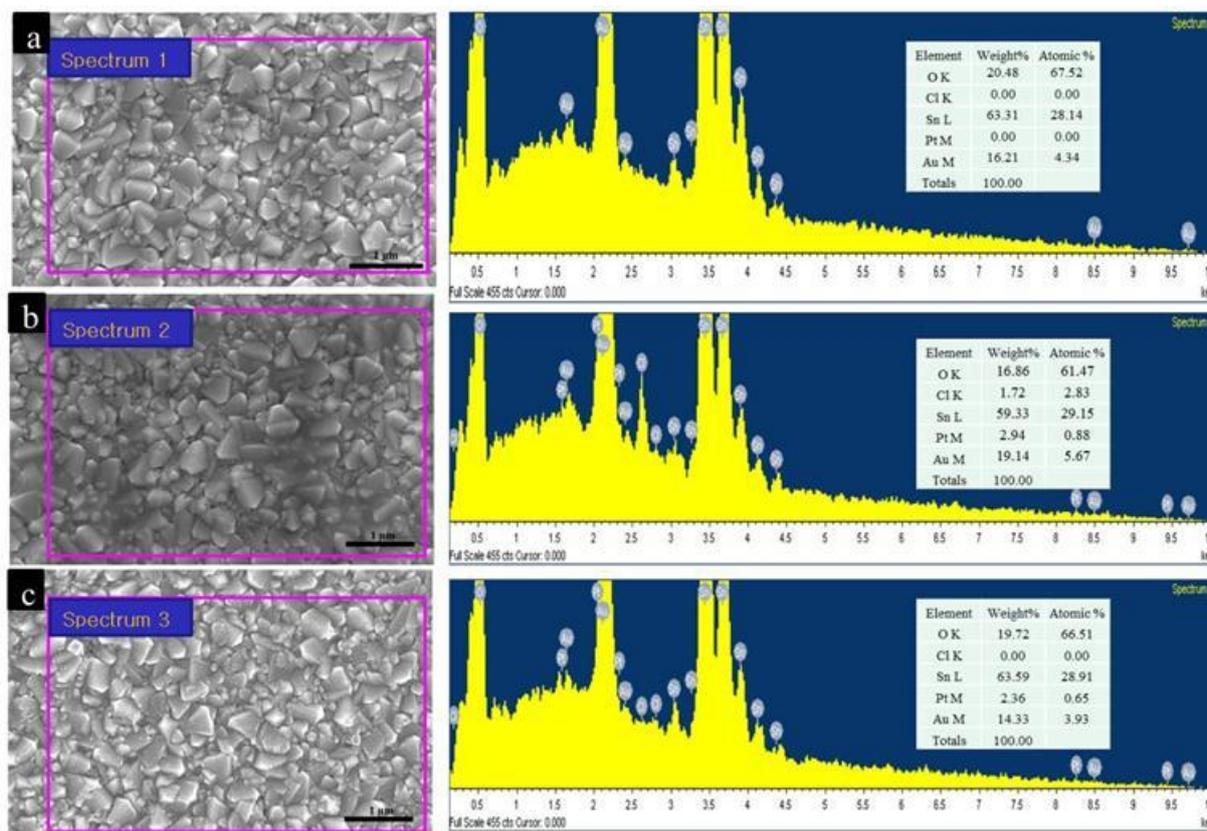
**Table S6.** Percentage of elemental composition on the surface of FTO glass.

Sample	Elemental Composition (%)			
	Sn	O	Pt	Cl
(a)	31.65	54.88	13.47	0
(b)	21.53	68.17	5.61	4.68
(c)	18.01	59.48	9.67	12.84



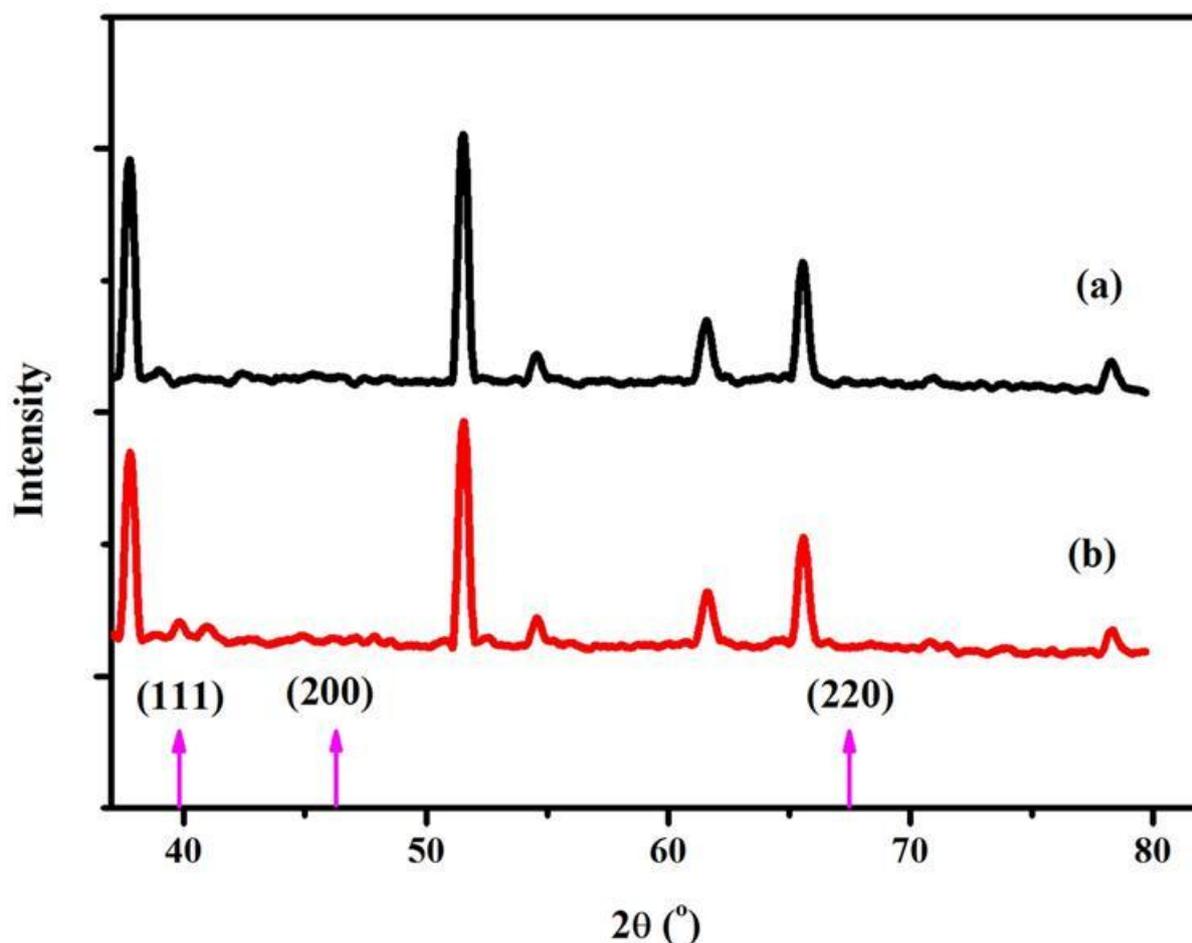
**Figure S6.** Change of temperature on the surface of FTO glass substrate during plasma reduction.

The temperature on the surface of FTO glass during plasma reduction was measured with a temperature measuring device (Testo 175). Temperature increased over 60°C within 60 sec and then fluctuated at the temperature between 60 °C and 70 °C. The substrate moving speed was 5 mm/s.



**Figure S7.** SEM and EDX spectrum of (a) bare FTO glass, (b) FTO glass after dropping  $H_2PtCl_6$  solution and drying solvent, and (c) FTO glass after reducing  $H_2PtCl_6$  with Ar plasma for 15 min.

The physiochemical conversion of  $H_2PtCl_6$  into metallic Pt was further confirmed by energy dispersive spectroscopy (EDX) as shown in Fig. S7. No Pt and Cl were observed on the EDX of bare FTO glass substrate. However, Pt and Cl peaks were observed when  $H_2PtCl_6$  solution was drop-coated on FTO glass substrate. After DPR, the Cl peak was completely removed from the EDX spectrum. The other peaks of Sn, O, and Au in EDX originated from the FTO glass substrate and the coated Au. Hence,  $H_2PtCl_6$  was completely converted into metallic Pt through the DPR process. It also confirmed that Pt-NPs became completely crystallized.



**Figure S8.** XRD patterns of FTO glass surface drop-coated with  $\text{H}_2\text{PtCl}_6$  precursor solution (a) before, and (b) after plasma reduction under one atmospheric pressure.

A Rigaku D/MAX-RC (12kW) diffractor with  $\text{CuK}_\alpha$  irradiation was used for the measurements of X-ray diffraction patterns of the samples before and after plasma treatment. Figure S8 shows the XRD patterns of FTO glass substrate drop-coated with  $\text{H}_2\text{PtCl}_6$  precursor solution before and after plasma reduction under one atmospheric pressure. It can be clearly seen that the diffraction peak of (111) Pt crystal planes was observed in the XRD pattern of (b), although no other peaks at (200) and (220) were observed. Even in the XRD pattern of (a), however, no peaks of (111) Pt crystal planes were observed. This can be further evidence of Pt-NPs formed through plasma reduction under atmospheric pressure.

**Table S7.** Weight measured at each process for confirming the “Pt missing”.

Sample #	Sample description	Weight ( $\mu\text{g}$ )
1	Initial FTO glass	2243470
2	FTO glass after plasma pretreatment	2243470
3	FTO glass after dropping 8 $\mu\text{l}$ of Pt precursor solution and completely drying solvent at 70°C for 10min	2243530
4	FTO glass after plasma reduction of Pt precursor	2243480

Amount of plasma etching =  $2243470 - 2243470 = 0$  ( $\mu\text{g}$ )

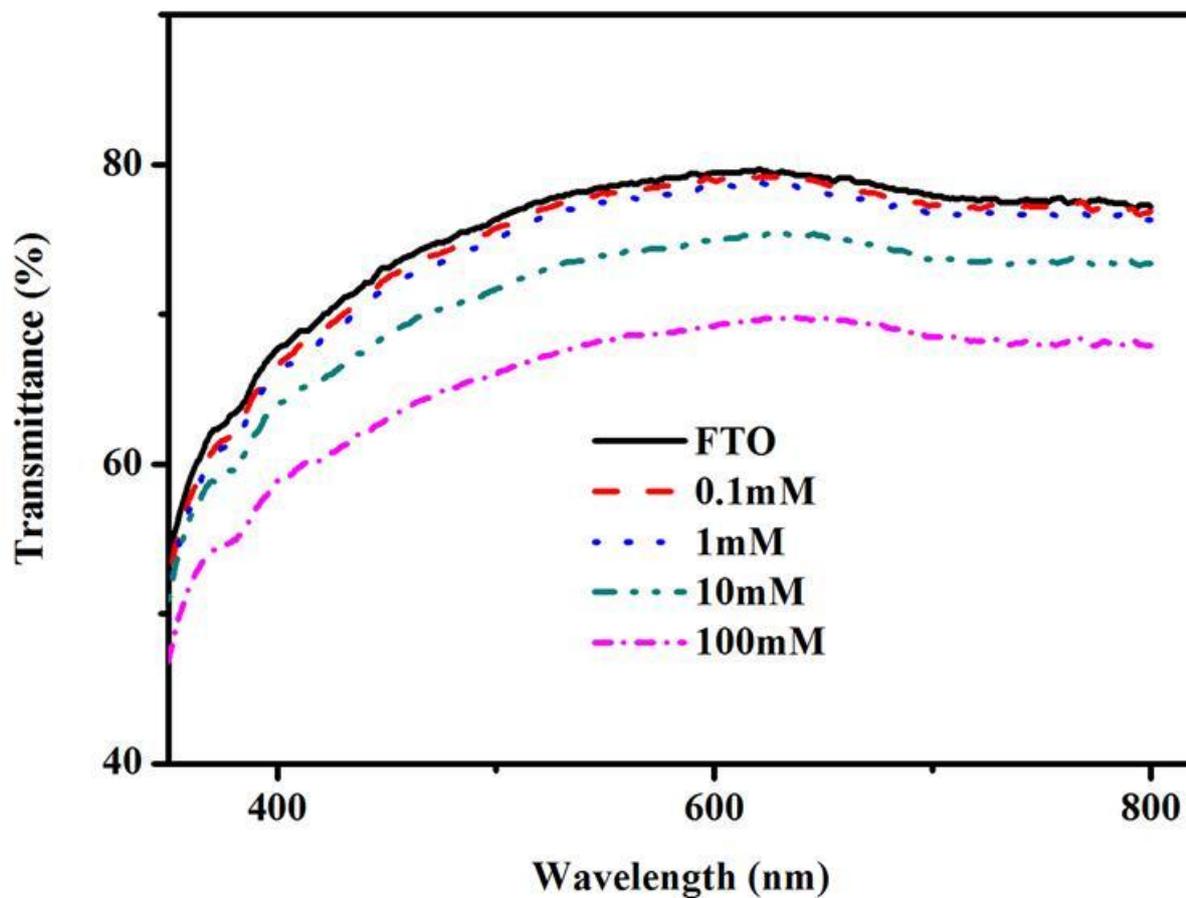
Amount of Pt precursor salt on FTO glass =  $2243530 - 2243470 = 60$  ( $\mu\text{g}$ )

Amount of Pt NPs after DPR =  $2243480 - 2243470 = 10$  ( $\mu\text{g}$ )

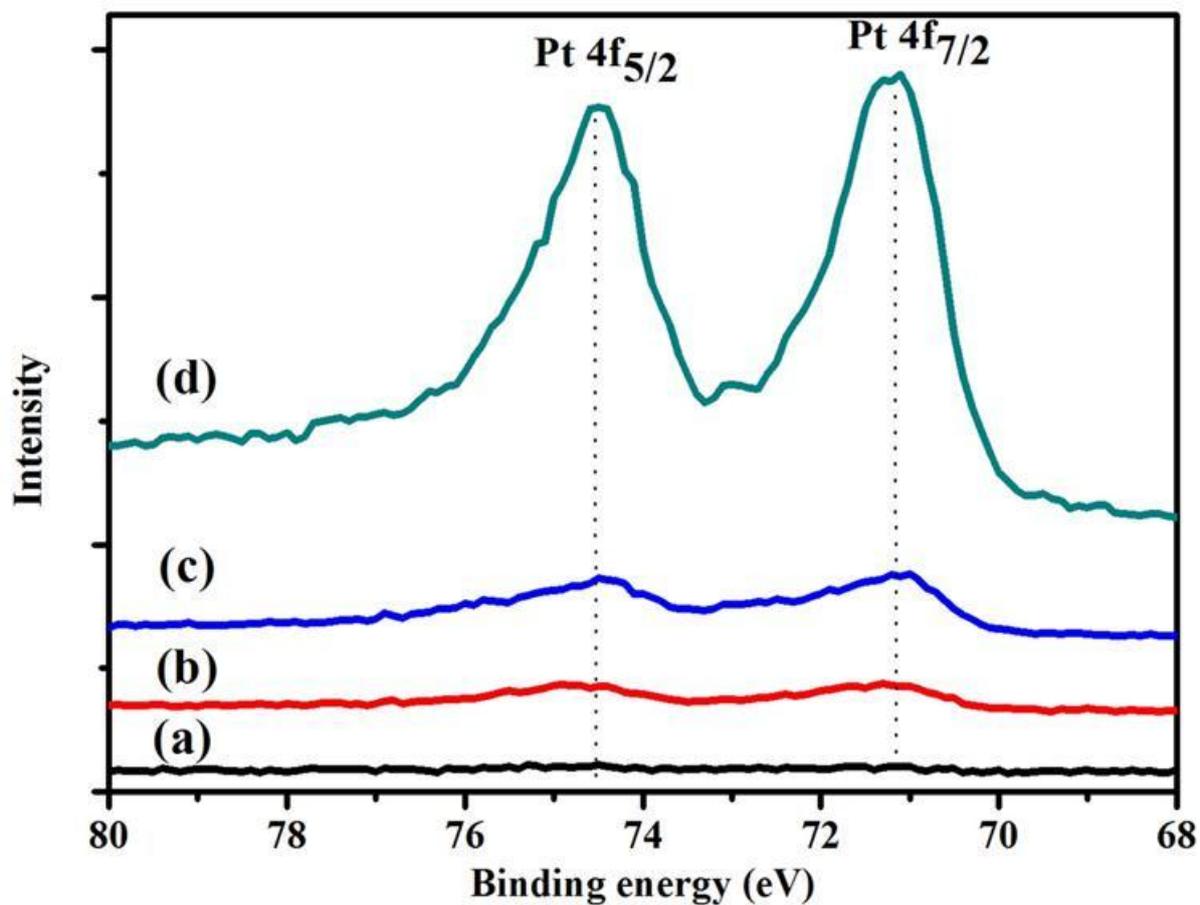
Amount of Pt metal from 8  $\mu\text{l}$  of Pt precursor solution

=  $(0.01(\text{M}) \times 0.000008(\text{l})) \times 409.8(\text{mole/g}) \times 195(\text{mole/g}) / 409.8(\text{mole/g}) = 15.6$  ( $\mu\text{g}$ )

Since the amount of “Pt missing” after DPR was estimated as 5.6  $\mu\text{g}$ , there must be some loss of Pt during DPR.



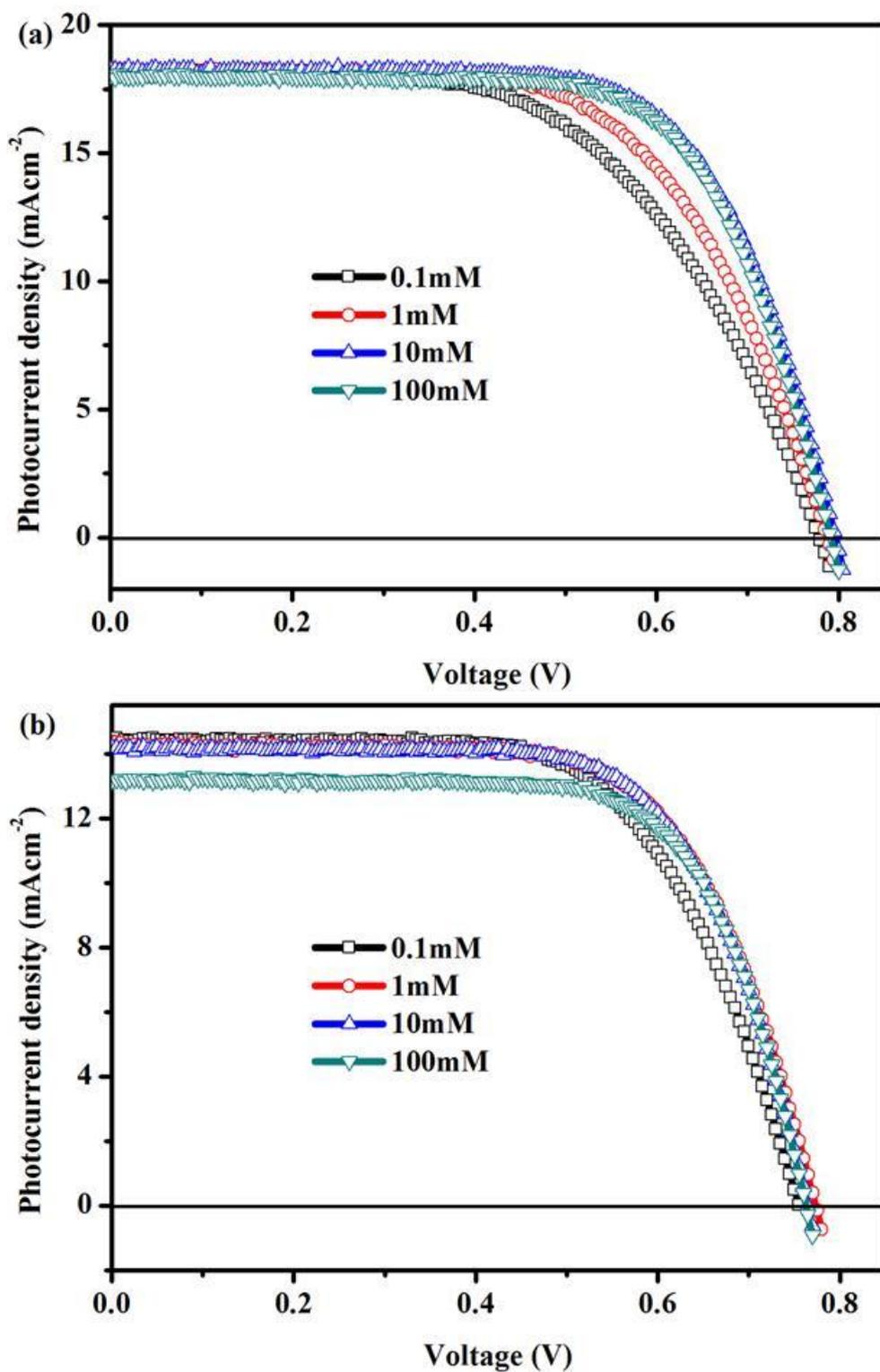
**Figure S9.** Transmittance change of Pt CEs prepared at the different concentrations of Pt precursor solution with respect to wavelength.



**Figure S10.** XPS spectra of Pt-NPs/FTO hybrid prepared with various H<sub>2</sub>PtCl<sub>6</sub>.xH<sub>2</sub>O concentrations of (a) 0.1 mM, (b) 1.0 mM, (c) 10mM, and (d) 100 mM in isopropyl alcohol.

**Table S8.** Percentage of elemental composition on the surface of FTO glass.

Sample	Elemental Composition (%)		
	O	Pt	Cl
(a)	98.83	1.17	0.00
(b)	95.91	4.09	0.00
(c)	80.29	19.71	0.00
(d)	75.38	24.62	0.00



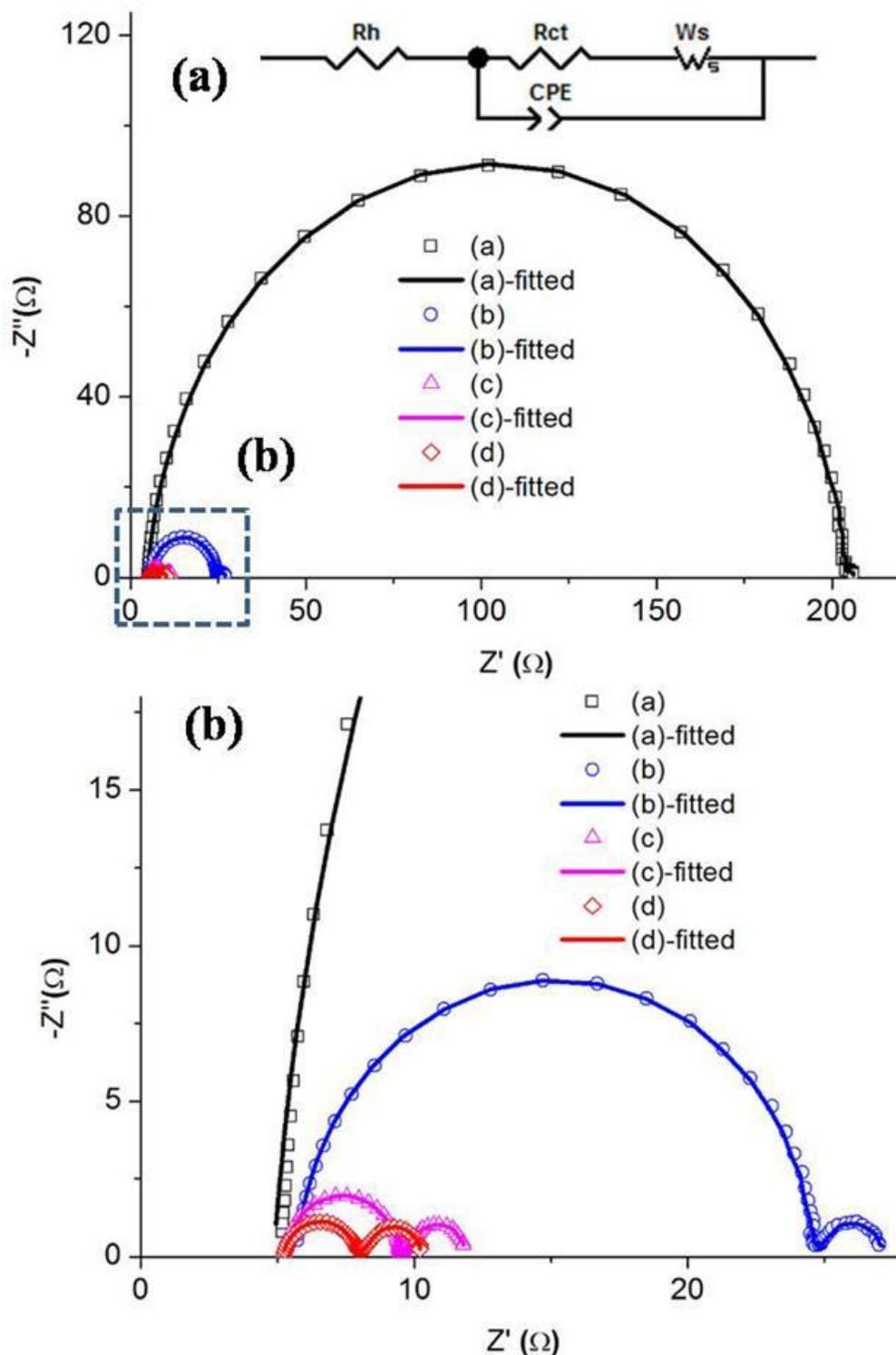
**Figure S11.** Current-voltage characteristics of four DSCs equipped with Pt-NPs/FTO hybrid electrodes synthesized at four different precursor concentrations; a) PA-side illumination, and b) CE-side illumination. The inset shows the relationships of the conversion efficiency of DSCs with concentration of Pt precursor solution.

**Table S9.** Photoelectric performances of four DSCs equipped with Pt-NPs/FTO hybrid electrode.

Counter electrode	$J_{sc}$ (mAcm <sup>-2</sup> )	$V_{oc}$ (mV)	$FF$ (%)	$\eta$ (%)
0.1mM <sup>a</sup>	17.78±0.47	772.50±6.45	57.59±0.74	7.91±0.18
0.1mM <sup>b</sup>	14.40±0.06	753.75±10.31	64.03±1.22	6.91±0.12
1mM <sup>a</sup>	18.14±0.61	782.50±6.45	60.98±2.17	8.65±0.17
1mM <sup>b</sup>	14.60±0.21	766.32±10.77	65.32±0.77	7.31±0.14
10mM <sup>a</sup>	18.48±0.25	795.00±4.08	67.27±0.83	9.88±0.12
10mM <sup>b</sup>	14.00±0.35	772.50±11.90	69.66±1.23	7.53±0.17
100mM <sup>a</sup>	18.55±0.40	785.00±12.91	67.59±0.78	9.84±0.13
100mM <sup>b</sup>	12.76±0.50	757.50±11.90	70.45±0.27	6.81±0.25

<sup>a</sup> photoelectric performance with PA-side illumination

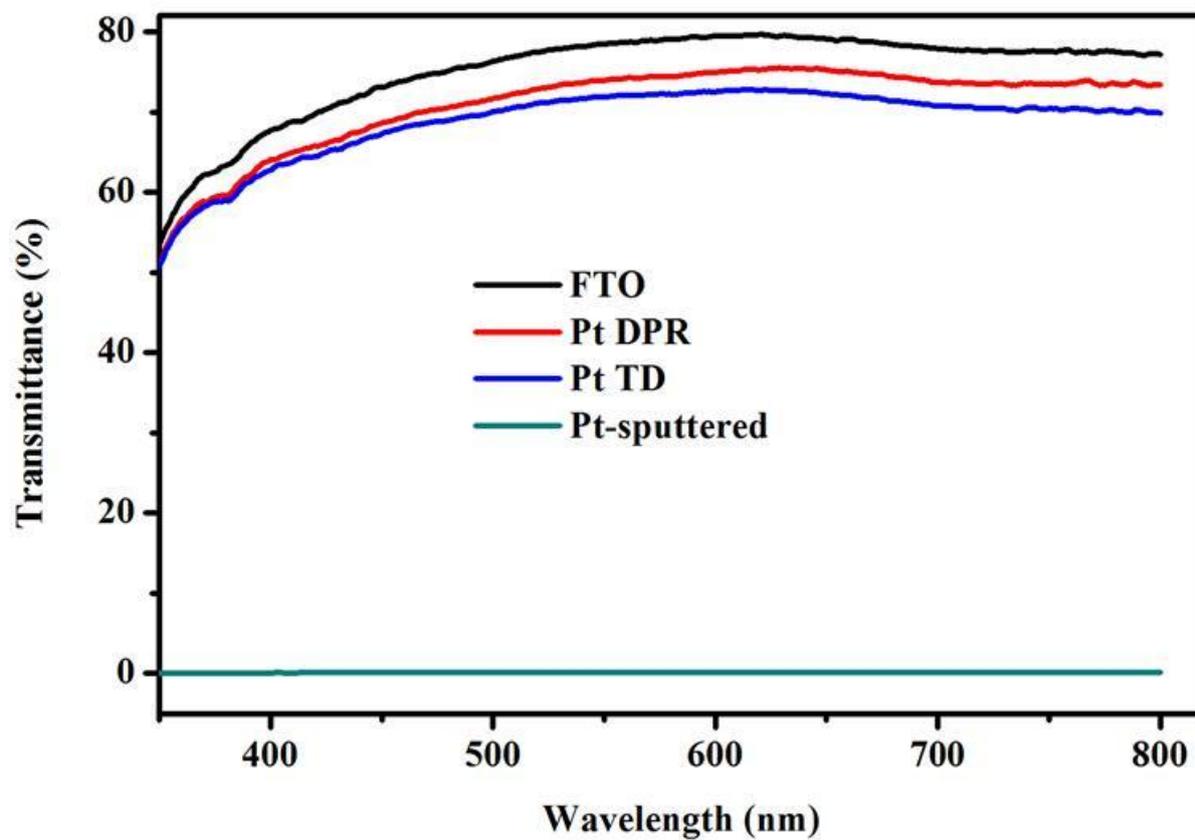
<sup>b</sup> photoelectric performance with CE-side illumination



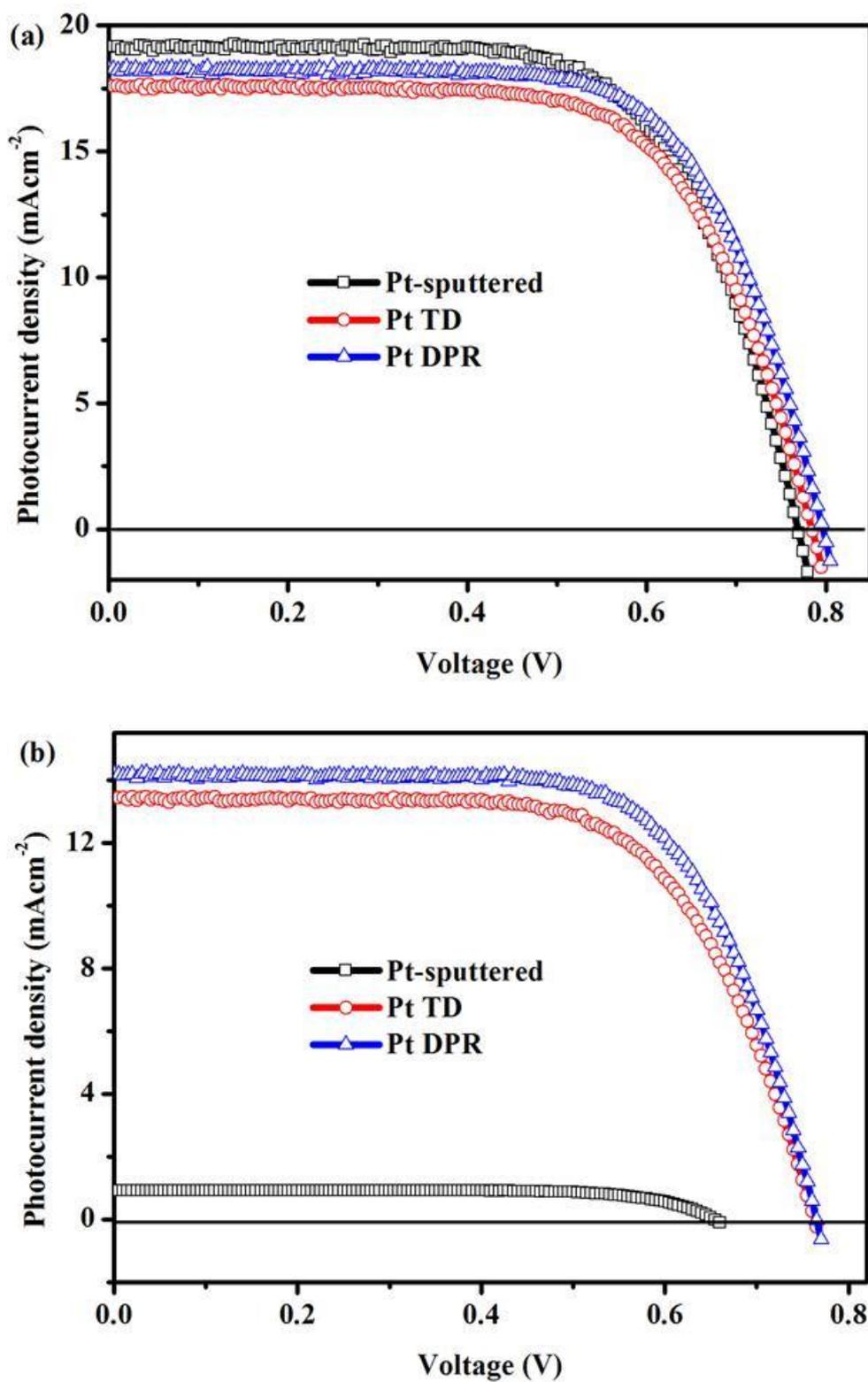
**Figure S12.** (a) Nyquist plots of the dummy cells fabricated with two identical Pt-NPs/FTO hybrids prepared with Pt precursor solutions containing different concentrations of Pt precursor, and (b) high magnification plots of the square area in (a). The top image shows the equivalent circuit diagram used to fit the observed impedance spectra in this figure.  $R_h$ : ohmic serial resistance;  $R_{ct}$ : charge-transfer resistance of the counter electrode; CPE: constant-phase element of the counter electrode, and  $W_s$ : Warburg impedance.

**Table S10.** Impedance parameters of the dummy cells fabricated with two identical Pt CEs prepared with Pt precursor solution containing different concentrations of Pt precursor estimated from the impedance spectra and equivalent circuit shown in Fig. S12.

Counter electrode	R <sub>h</sub> ( $\Omega\text{cm}^2$ )	R <sub>ct</sub> ( $\Omega\text{cm}^2$ )	CPE-T ( $\text{Fcm}^{-2}$ )	CPE-P	W <sub>s</sub>		
					R	T	P
(a)-0.1mM	1.20	48.68	$1.27 \times 10^{-5}$	0.96	0.63	0.93	0.5
(b)-1mM	1.40	4.61	$1.63 \times 10^{-5}$	0.96	0.63	0.68	0.5
(c)-10mM	1.30	1.01	$2.65 \times 10^{-5}$	0.96	0.61	0.73	0.5
(d)-100mM	1.27	0.67	$14.0 \times 10^{-5}$	0.90	0.57	0.51	0.5



**Figure S13.** Transmittance change of Pt CEs prepared through DPR, TD, and sputtering with respect to wavelength.



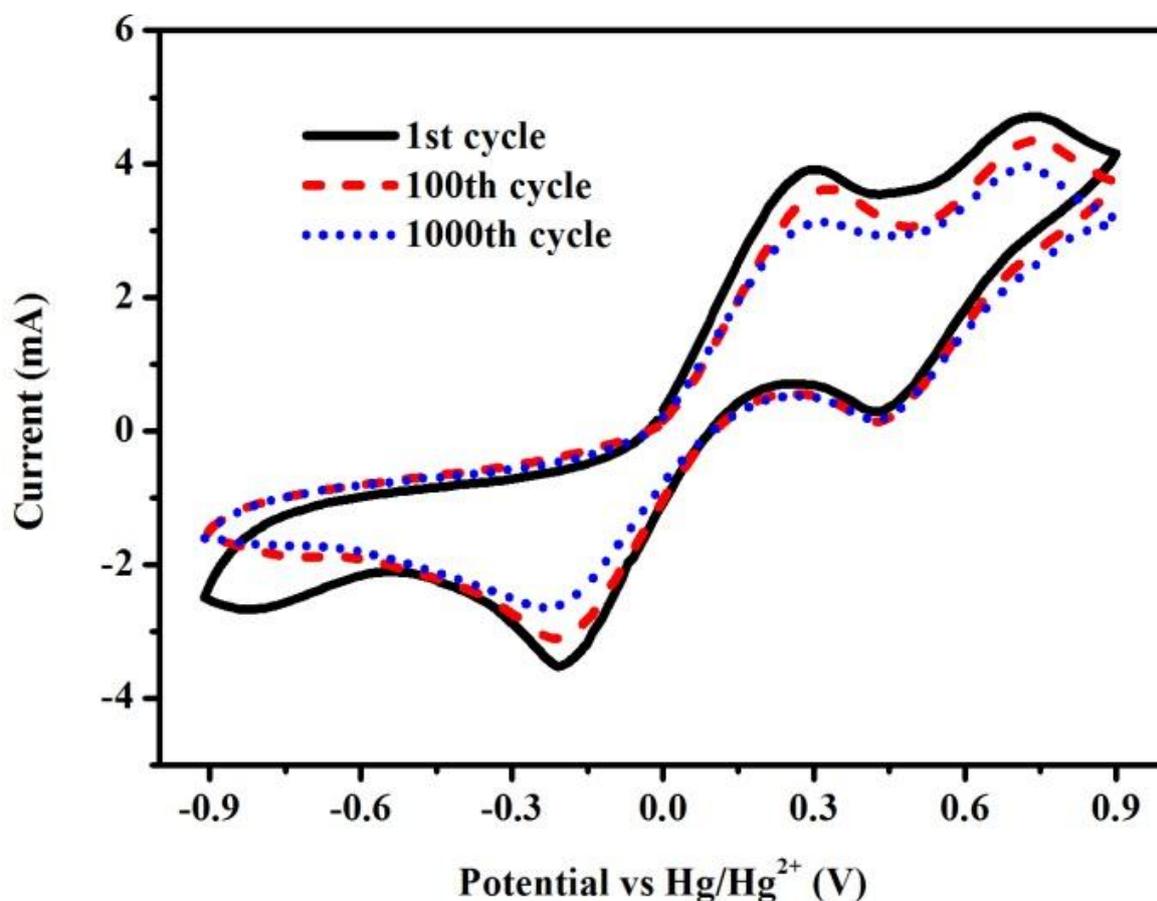
**Figure S14.** Current-voltage characteristics of three DSCs equipped with Pt-based FTO counter electrodes prepared through three different methods; a) PA-side illumination, and b) CE-side illumination.

**Table S11.** Photoelectric performances of three cells in Figure S14.

Counter electrode	$J_{sc}$ (mAcm <sup>-2</sup> )	$V_{oc}$ (mV)	$FF$ (%)	$\eta$ (%)
Pt-sputtered <sup>a</sup>	19.16±0.10	775.00±7.07	66.72±0.73	9.91±0.15
Pt-sputtered <sup>b</sup>	0.93±0.10	637.5±11.9	71.32±2.23	0.42±0.05
Pt-TD <sup>a</sup>	17.69±0.23	778.75±7.50	65.76±1.08	9.06±0.23
Pt-TD <sup>b</sup>	13.26±0.67	756.25±8.53	67.40±2.73	6.75±0.19
Pt-DPR <sup>a</sup>	18.48±0.25	795.00±4.08	67.27±0.83	9.88±0.12
Pt-DPR <sup>b</sup>	14.00±0.35	772.5±11.9	69.66±1.23	7.53±0.17

<sup>a</sup> photoelectric performance with PA-side illumination

<sup>b</sup> photoelectric performance with CE-side illumination



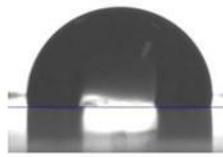
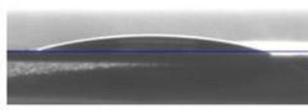
**Figure S15.** Current-voltage curves over time for the redox system with the Pt NPs working electrode prepared by dry plasma reduction from 10mM of Pt precursor in IPA and Pt-mesh counter electrode.

The stability of the electrode materials is very important for applications. The DSC with the Pt NP as counter electrode prepared by dry plasma reduction showed good stability. This stability was confirmed by the stability of the current-voltage curves over time for the redox system with the Pt NP working electrode and Pt mesh counter electrode (Figure S15) [S1]. Slight decrease of the current was observed after the 1000<sup>th</sup> cycle. It is, however, better than that of Pt counter electrode prepared by thermal decomposition [S2].

**Table S12.** Impedance parameters of three DSCs with Pt CEs prepared by sputtering, TD, and DPR, estimated from the impedance spectra and equivalent circuit shown in Figure 3(c).

Counter electrode	$R_h$ ( $\Omega\text{cm}^2$ )	$R_{ct1}$ ( $\Omega\text{cm}^2$ )	CPE1-T ( $\text{Fcm}^{-2}$ )	CPE1-P	$R_{ct2}$ ( $\Omega\text{cm}^2$ )	$W_s$			CPE2-T ( $\text{Fcm}^{-2}$ )	CPE2- P
						$R$	$T$	$P$		
Pt-sputtered	1.60	0.72	$1.52 \times 10^{-5}$	0.83	3.14	2.08	0.47	0.5	$7.55 \times 10^{-3}$	0.92
Pt-TD	2.34	1.02	$4.37 \times 10^{-5}$	0.91	3.30	1.86	0.44	0.5	$7.76 \times 10^{-3}$	0.90
Pt-DPR	2.38	0.68	$5.24 \times 10^{-5}$	0.92	2.93	2.30	0.49	0.5	$6.33 \times 10^{-3}$	0.92

**Table S13.** Water contact angle of bare FTO glass and PET/ITO substrate before and after plasma treatment.

Substrate	Contact angle	image
FTO-glass	$33.6 \pm 0.4$	
ITO-PET before plasma treatment	$94.3 \pm 0.2$	
ITO-PET after plasma treatment	$15.2 \pm 0.4$	

## References

[S1] V. D. Dao, S. H. Ko, H. S. Choi, J. K Lee, *J. Mater. Chem.*, 2012, **22**, 14023

[S2] X. Mei, S. Cho, B. Fan and J. Ouyang, *Nanotechnology*, 2010, **21**, 395202